



Material Composition Declaration

This document is a declaration of the substances within the Digi listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which Digi has engineering responsibility.

Person completing this declaration:

Name:	Steve Bowen
Title:	Sr. Process Engineer
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Item Information:

Item Number	CC-MX-JM8D-ZN
Item Name	ConnectCore 8x SoM QuadX, 8GB eMMC, 2GB LPDDR4
Effective Date:	2/1/2021
Alternate Item:	
Comment:	

Person certifying the declaration is true and complete:

Name:	Steve Bowen
Title:	Sr. Process Engineer
Phone:	952-912-3444
Email:	RoHS@digicom
Date:	2/1/2021

RoHS Material Composition Declaration:

RoHS3 Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead, Mercury, Hexavalent chromium, Polybrominated biphenyls (PBB), Polybrominated diphenyl ethers (PBDE), Bis (2-ethylhexyl) phthalate (DEHP), Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP); and Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for: Cadmium (Cd)

Declaration:	1 Item does not contain RoHS restricted substances per the definition above
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Exemption:

Reach SVHC EU Declaration:

Digi International meets the requirements of the latest REACH Substances of Very High Concern (SVHC) per the most recent amendments to Europe Union (EU) Regulations No 1907/2006. Please refer to the following for the most current candidate list of substances: <http://echa.europa.eu/candidate-list-table>.

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